GP ELECTRONICS (HK) LIMITED

GP Electronics (HK) Ltd. is a member of a reputable listed group of companies in Hong Kong and Singapore with diversified portfolio of investment in Asia and overseas. We are strong in design and manufacturing of professional & high end audio products. Leveraging on the manufacturing and distribution expertise, we now have access to an extensive network spanning over 10 countries in the world including a design center in Hong Kong, PRC and UK. To cope with strategic growth in electronics business, we are now offering an excellent career opportunity to a high calibre and dynamic candidate in joining our Executive Development Program.

Assistant Engineer – Acoustics Development / Connectivity & Wireless (3-year Executive Development Program)

Joining our Engineering Team as an Assistant Engineer, you will perform project related software or hardware architecture, design, implementation, test and improvement; and assist project leader in completing the project tasks. With opportunity to join our 3-year development program, you will receive a series of technical, management & leadership trainings which lead you to be a future successor in the organization.

Responsibilities

- Design, implement, test and improve hardware and software architecture
- Understand the market and technical needs of the product to be developed
- Prepare project document or research, analysis and evaluation report
- Assist in troubleshooting, analyzing and solve any technical issues in whole product development cycle
- Assist in the product verification and validation
- Assist in building and tests prototype sample stage to mass production
- Collaborate with functional project team members within company and overseas
- Perform all tasks assigned by the supervisor

Requirements

For Acoustics Development Team:

- Bachelor degree or above in Material Science or related discipline
- Good knowledge of manufacturing processes, design for manufacturing and ISO quality management systems is required
- High mobility and willing to take overseas assignment is preferable
- Working location: Hong Kong / Shenzhen / Huizhou
For Connectivity & Wireless Team:
- Bachelor degree or above in Electronic Engineering or related discipline
- Good knowledge of electronic, RF, wireless/data communication, and/or signal processing is required
- Willing to have frequent travel to our Shenzhen R&D Centre & Huizhou factory
- Working location: Hong Kong

In General:
- Knowledge of CAM / CAD tools like Pspice, Protel or Pads and simulation tools is an advantage
- Proficient in English and Chinese, fluent in Putonghua
- Good interpersonal and communication skills

Company Benefits
Besides promising career development opportunity, we work 5 days a week and offer competitive remuneration package including double pay, medical benefit and non-contributory provident fund.

Application
Interested parties, please send your application with a covering letter, CV (please indicate your latest CGPA score and extra-curricular activities), the latest transcript and public exam result to email hr_dept@gpe-hkg.com.

Please visit our company website at www.gp-industries.com and www.kef.com for more information about us.

We are an equal opportunities employer. Personal data collected will be treated as strictly confidential and used for recruitment purpose only.